

SP8910 (MP) 5GHZ ÷ 10 Fixed Modulus Divider Preliminary Information

The SP8910 is one of a range of very high speed low power prescalers for professional applications. The dividing elements are static D type flip flops and therefore allow operation down to DC if the drive signal is a pulse waveform with fast risetime. The output stage has internal100 ohm pull up resistors, giving a 0.5V p-p output. If required, an external 100 ohm can be connected in parallel to give a 50 ohm output.

Features

- Very High Operating Speed
- · Operation down to DC with Square Wave Input
- Silicon Technology for Low Phase Noise
- (Typically better than -140dBc/Hz at 1KHz)
- 5V Single Supply Operation
- Low Power Dissipation: 340mW (Typ.)
- Surface Mount Plastic Package

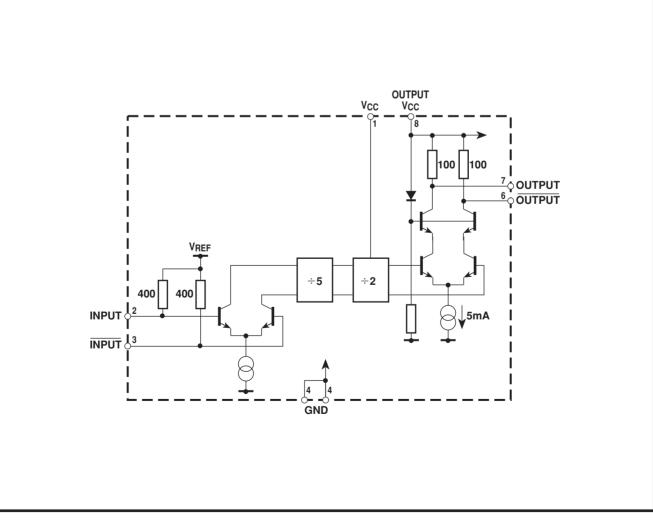
DS4360

May 2002

Ordering Information SP8910/KG/MP1S (tubes) SP8910/KG/MP1T (tape and reel)

Absolute Maximum Ratings

Supply voltage, V _{CC}	6·5V
Storage temperature	-65°C to +150°C
Maximum junction temperate	ure +150°C
Prescaler input voltage	2·5Vp-p
Operating temperature	KG-40°C to $+85^\circ\text{C}\text{T}_{\text{CASE}}$



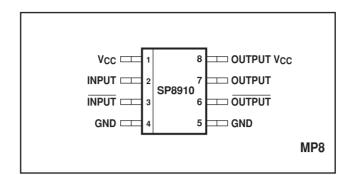


Figure 2 - Pin connections - top view

Electrical Characteristics

These characteristics are guaranteed by either production test or design over the following range of operating conditions unless otherwise stated: $T_{AMB} = -40^{\circ}C$ to $+85^{\circ}C$, $V_{CC} = 4.75V$ to 5.25V

	Pin	Value				
Characteristic		Min.	Тур.	Max.	Units	Conditions
Supply current	1, 8	-	68	92	mA	
Input frequency	2, 3	1.0	-	5.0	GHz	RMS sinewave
Input frequency	2, 3	1.0		5.5	GHz	RMS sinewave, $T_{CASE} = -55^{\circ}C$ to $+85^{\circ}C$
Input sensitivity	2, 3	-	-	180	mVrms	$f_{IN} = 1GHz$ and 4.2GHz
Input sensitivity	2, 3	-	-	570	mVrms	f _{IN} = 5GHz
Input overload	2, 3	440	-	-	mVrms	$f_{IN} = 1 GHz$ and $3 GHz$
Input overload	2, 3	700	-	-	mVrms	f _{IN} = 5.0GHz and 3.8GHz
Output voltage	6, 7	-	0.25	-	Vp-р	Into 100 Ω pullup resistor
Output power	6, 7	_18·0	-9.0	-4.0	dBm	$f_{IN} = 1GHz$ and 5GHz (see note 1)

NOTE

1. Measured into 50Ω measuring instrument in parallel with 100Ω pullup resistor. See Figure 5.

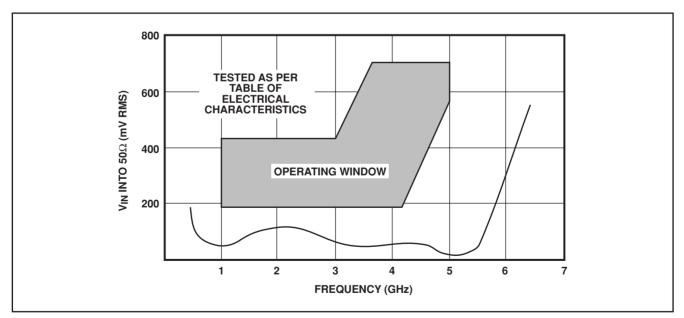


Figure 3 - Typical input sensitiviy (sinewave drive)

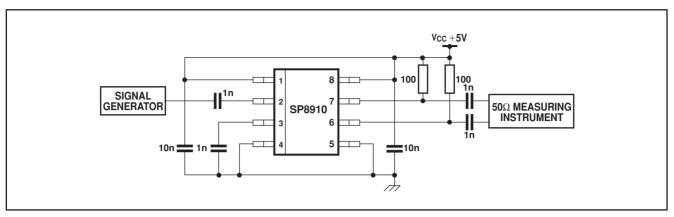


Figure 4 - Typical application and test circuit

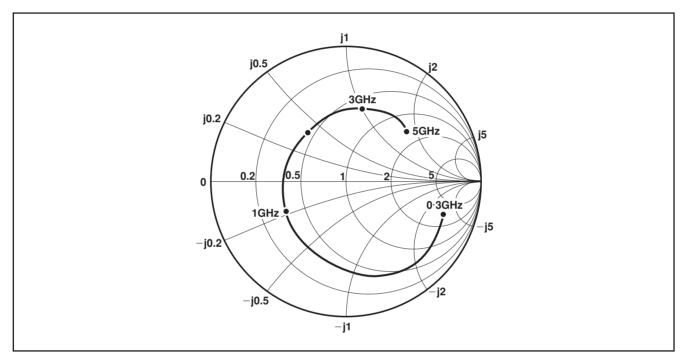


Figure 5 - Typical input impedance

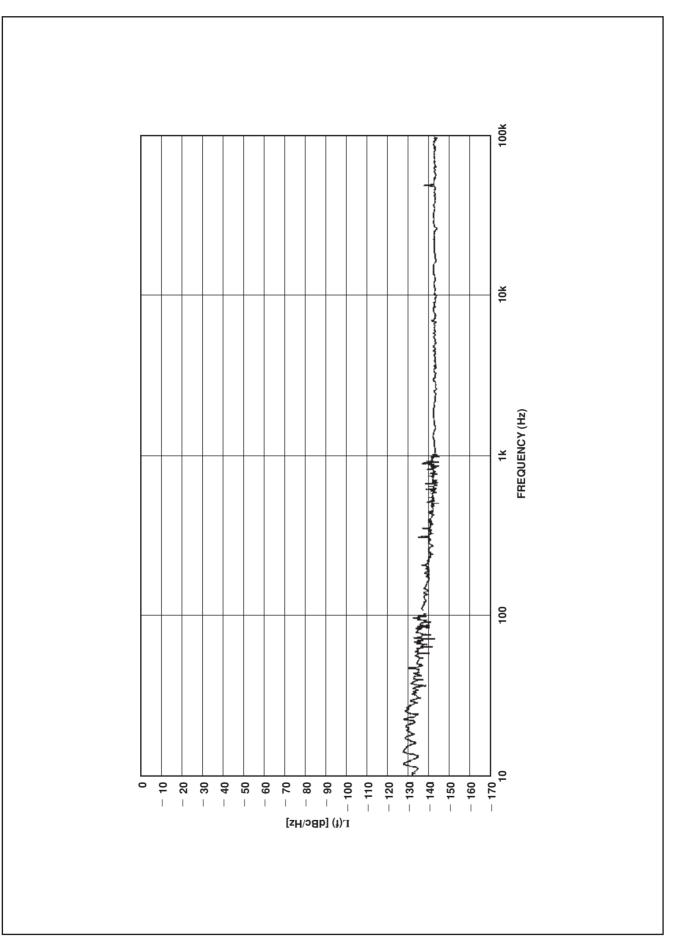
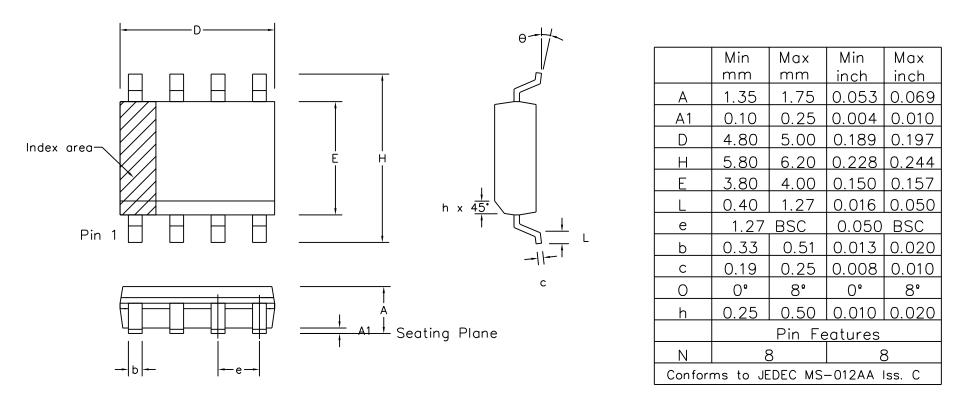


Figure 6 - Typical phase noise, input frequency = 3GHz



Notes:

- 1. The chamfer on the body is optional. If not present, a visual index feature, e.g. a dot, must be located within the cross-hatched area.
- 2. Controlling dimensions are in inches.
- 3. Dimension D do not include mould flash, protusion or gate burrs. These shall not exceed 0.006" per side.
- 4. Dimension E1 do not include inter-lead flash or protusion. These shall not exceed 0.010" per side.
- 5. Dimension b does not include dambar protusion / intrusion. Allowable dambar protusion shall be 0.004" total in excess of b dimension.

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ISSUE	1	2	3	4	5	Previous package codes	Package Outline for	
ACN	6745	201936	202595	203705	212424	MP/S	8 lead SOIC (0.150" Body width)	
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